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Team Nexperia

# PDTD113E series

# NPN 500 mA, 50 V resistor-equipped transistors; R1 = 1 k $\Omega$ , R2 = 1 k $\Omega$

Rev. 02 — 16 November 2009

Product data sheet

## 1. Product profile

#### 1.1 General description

500 mA NPN Resistor-Equipped Transistors (RET) family.

Table 1. Product overview

| Type number  | Package | Package |          |           |
|--------------|---------|---------|----------|-----------|
|              | NXP     | JEITA   | JEDEC    |           |
| PDTD113EK    | SOT346  | SC-59A  | TO-236   | PDTB113EK |
| PDTD113ES[1] | SOT54   | SC-43A  | TO-92    | PDTB113ES |
| PDTD113ET    | SOT23   | -       | TO-236AB | PDTB113ET |

<sup>[1]</sup> Also available in SOT54A and SOT54 variant packages (see Section 2).

#### 1.2 Features

- Built-in bias resistors
- Simplifies circuit design
- 500 mA output current capability
- Reduces component count
- Reduces pick and place costs
- ±10 % resistor ratio tolerance

#### 1.3 Applications

- Digital application in automotive and industrial segments
- Controlling IC inputs

- Cost saving alternative for BC817 series in digital applications
- Switching loads

#### 1.4 Quick reference data

Table 2. Quick reference data

| Symbol         | Parameter                 | Conditions | Min | Тур | Max | Unit |
|----------------|---------------------------|------------|-----|-----|-----|------|
| $V_{CEO}$      | collector-emitter voltage | open base  | -   | -   | 50  | V    |
| I <sub>O</sub> | output current (DC)       |            | -   | -   | 500 | mA   |
| R1             | bias resistor 1 (input)   |            | 0.7 | 1   | 1.3 | kΩ   |
| R2/R1          | bias resistor ratio       |            | 0.9 | 1.0 | 1.1 |      |



## 2. Pinning information

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output (collector)

Table 3. **Pinning** Simplified outline Pin **Description Symbol** SOT54 1 input (base) 2 output (collector) 3 GND (emitter) 001aab347 SOT54A 1 input (base) 2 output (collector) 3 GND (emitter) 001aab348 006aaa145 **SOT54** variant 1 input (base) 2 output (collector) 3 GND (emitter) 001aab447 006aaa145 **SOT23, SOT346** 1 input (base) 3 2 GND (emitter)

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sym007

006aaa144

## 3. Ordering information

Table 4. Ordering information

| Type number  | Package |   |         |  |  |  |
|--------------|---------|---|---------|--|--|--|
|              | Name    | Description   | Version |  |  |  |
| PDTD113EK    | SC-59A  | plastic surface mounted package; 3 leads                    | SOT346  |  |  |  |
| PDTD113ES[1] | SC-43A  | plastic single-ended leaded (through hole) package; 3 leads | SOT54   |  |  |  |
| PDTD113ET    | -       | plastic surface mounted package; 3 leads                    | SOT23   |  |  |  |

<sup>[1]</sup> Also available in SOT54A and SOT54 variant packages (see Section 2 and Section 9).

## 4. Marking

Table 5. Marking codes

| Type number | Marking code <sup>[1]</sup> |
|-------------|-----------------------------|
| PDTD113EK   | E1                          |
| PDTD113ES   | D113ES                      |
| PDTD113ET   | *7R                         |

<sup>[1] \* = -:</sup> made in Hong Kong

## 5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter                 | Conditions                  | Min             | Max  | Unit |
|------------------|---------------------------|-----------------------------|-----------------|------|------|
| $V_{CBO}$        | collector-base voltage    | open emitter                | -               | 50   | V    |
| $V_{CEO}$        | collector-emitter voltage | open base                   | -               | 50   | V    |
| V <sub>EBO</sub> | emitter-base voltage      | open collector              | -               | 10   | V    |
| VI               | input voltage             |                             |                 |      |      |
|                  | positive                  |                             | -               | +10  | V    |
|                  | negative                  |                             | -               | -10  | V    |
| Io               | output current (DC)       |                             | -               | 500  | mA   |
| P <sub>tot</sub> | total power dissipation   | $T_{amb} \le 25  ^{\circ}C$ | [1]             |      |      |
|                  | SOT346                    |                             | -               | 250  | mW   |
|                  | SOT54                     |                             | -               | 500  | mW   |
|                  | SOT23                     |                             | -               | 250  | mW   |
| T <sub>stg</sub> | storage temperature       |                             | -65             | +150 | °C   |
| Tj               | junction temperature      |                             | -               | 150  | °C   |
| T <sub>amb</sub> | ambient temperature       |                             | <del>-</del> 65 | +150 | °C   |

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

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<sup>\* =</sup> p: made in Hong Kong

<sup>\* =</sup> t: made in Malaysia

<sup>\* =</sup> W: made in China

## 6. Thermal characteristics

Table 7. Thermal characteristics

| Symbol        | Parameter                                   | Conditions  | Min        | Тур | Max | Unit |
|---------------|---|-------------|------------|-----|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | <u>[1]</u> |     |     |      |
|               | SOT346                                      |             | -          | -   | 500 | K/W  |
|               | SOT54                                       |             | -          | -   | 250 | K/W  |
|               | SOT23                                       |             | -          | -   | 500 | K/W  |

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

## 7. Characteristics

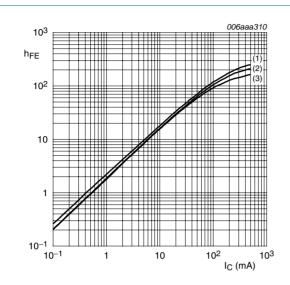
Table 8. Characteristics

 $T_{amb} = 25$  °C unless otherwise specified.

| Symbol             | Parameter                            | Conditions  | Min | Тур | Max | Unit |
|--------------------|--------------------------------------|---|-----|-----|-----|------|
| $I_{CBO}$          | collector-base cut-off               | $V_{CB} = 40 \text{ V}; I_{E} = 0 \text{ A}$                  | -   | -   | 100 | nA   |
|                    | current                              | V <sub>CB</sub> = 50 V; I <sub>E</sub> = 0 A                  | -   | -   | 100 | nA   |
| I <sub>CEO</sub>   | collector-emitter cut-off current    | $V_{CE} = 50 \text{ V}; I_{B} = 0 \text{ A}$                  | -   | -   | 0.5 | μΑ   |
| I <sub>EBO</sub>   | emitter-base cut-off current         | $V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$                   | -   | -   | 4   | mA   |
| h <sub>FE</sub>    | DC current gain                      | $V_{CE} = 5 \text{ V}; I_{C} = 50 \text{ mA}$                 | 33  | -   | -   |      |
| V <sub>CEsat</sub> | collector-emitter saturation voltage | $I_C = 50 \text{ mA}; I_B = 2.5 \text{ mA}$                   | -   | -   | 0.3 | V    |
| $V_{I(off)}$       | off-state input voltage              | $V_{CE} = 5 \text{ V}; I_{C} = 100 \mu\text{A}$               | 0.6 | 1.1 | 1.5 | V    |
| V <sub>I(on)</sub> | on-state input voltage               | $V_{CE} = 0.3 \text{ V}; I_{C} = 20 \text{ mA}$               | 1.0 | 1.4 | 1.8 | V    |
| R1                 | bias resistor 1 (input)              |   | 0.7 | 1   | 1.3 | kΩ   |
| R2/R1              | bias resistor ratio                  |   | 0.9 | 1   | 1.1 |      |
| C <sub>c</sub>     | collector capacitance                | $V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 100 MHz | -   | 7   | -   | pF   |

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NPN 500 mA resistor-equipped transistors; R1 = 1 k $\Omega$ , R2 = 1 k $\Omega$ 



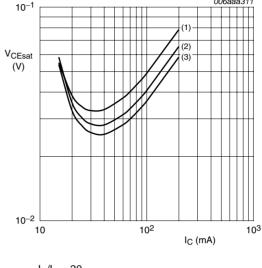
$$V_{CE} = 5 V$$

(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = -40 \, ^{\circ}C$$

Fig 1. DC current gain as a function of collector current; typical values



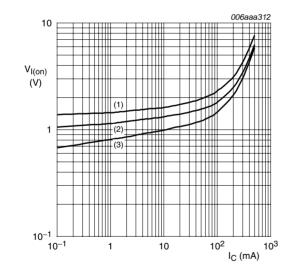
$$I_{\rm C}/I_{\rm B} = 20$$

(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = -40 \, ^{\circ}C$$

Fig 2. Collector-emitter saturation voltage as a function of collector current; typical values



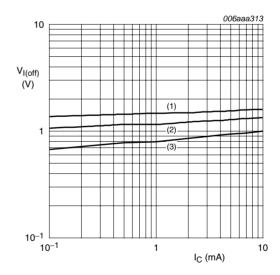
$$V_{CE} = 0.3 \text{ V}$$

(1) 
$$T_{amb} = -40 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = 100 \, ^{\circ}C$$

Fig 3. On-state input voltage as a function of collector current; typical values



$$V_{CE} = 5 \text{ V}$$

(1) 
$$T_{amb} = -40 \, ^{\circ}C$$

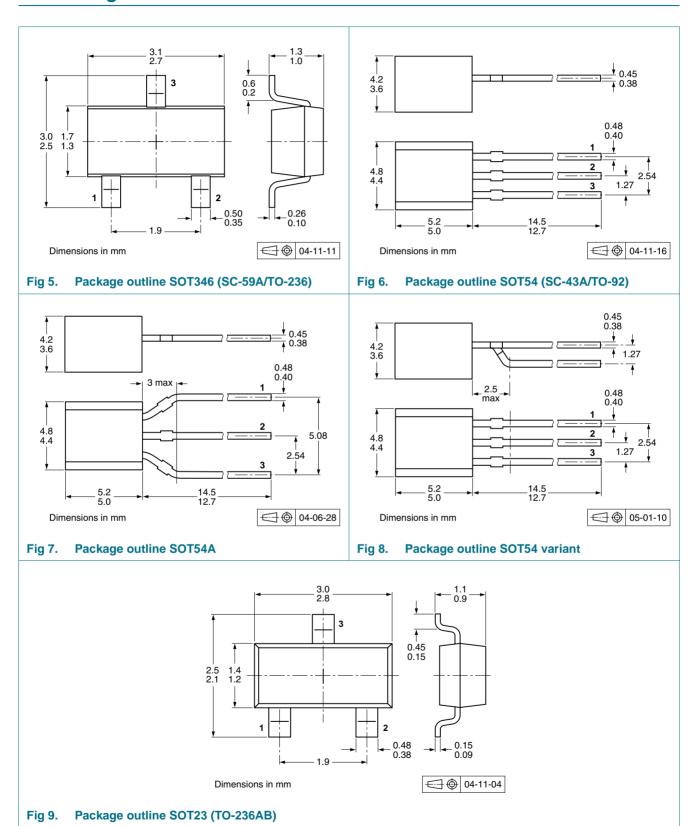
(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = 100 \, ^{\circ}C$$

Fig 4. Off-state input voltage as a function of collector current; typical values

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## 8. Package outline



## 9. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

| Type number | Package       | Description                    | Packing quantity |      |       |  |
|-------------|---------------|--------------------------------|------------------|------|-------|--|
|             |               |                                | 3000             | 5000 | 10000 |  |
| PDTD113EK   | SOT346        | 4 mm pitch, 8 mm tape and reel | -115             | -    | -135  |  |
| PDTD113ES   | SOT54         | bulk, straight leads           | -                | -412 | -     |  |
|             | SOT54A        | tape and reel, wide pitch      | -                | -    | -116  |  |
|             |               | tape ammopack, wide pitch      | -                | -    | -126  |  |
|             | SOT54 variant | bulk, delta pinning            | -                | -112 | -     |  |
| PDTD113ET   | SOT23         | 4 mm pitch, 8 mm tape and reel | -215             | -    | -235  |  |

<sup>[1]</sup> For further information and the availability of packing methods, see Section 12.



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NPN 500 mA resistor-equipped transistors; R1 = 1 k $\Omega$ , R2 = 1 k $\Omega$ 

## 10. Revision history

#### Table 10. Revision history

**Product data sheet** 

| Document ID    | Release date | Data sheet status  | Change notice | Supersedes     |
|----------------|--------------|--|---------------|----------------|
| PDTD113E_SER_2 | 20091116     | Product data sheet   | -             | PDTD113E_SER_1 |
| Modifications: |              | eet was changed to reflect<br>w legal definitions and disc |               |                |
| PDTD113E_SER_1 | 20050414     | Product data sheet   | -             | -              |

## 11. Legal information

#### 11.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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PDTD113E\_SER\_2

## PDTD113E series

#### NPN 500 mA resistor-equipped transistors; R1 = 1 k $\Omega$ , R2 = 1 k $\Omega$

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